Hughes Circuits, Inc.

The Experts in

Printed Circuits

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A Performance-oriented Legacy

Founded in 1999 by Jerry Hughes

- 47 years in the circuit board business, founding 2 successful prototype PCB companies
- Spearheaded and implemented in-house prototype facilities within Burroughs, NCR and Unisys
- The underlying theme of the company strong frontend and engineering support
- Keen understanding of time sensitive products and constraints





- Privately Held Corporation
- Circuit Board Layout, Fabrication, and Assembly
- All processes within same facility, in San Diego
- Many years experience in Commercial, Medical and Military markets
- Fully EPA and environmentally compliant
- 160 Employees
- Shifts: 3 Fab, 2 Assembly
- SD Business Journal Top 100.
- 50,000 Sq Ft ITAR Facility







- CAGE 1KXU6
- Active in Trade Shows
- Growing 15%+ Yr/Yr
- Operating at 65% Capacity
- Recent Capital Investments
 - Additional LDI
 - Additional LASER
 - •. Additional AOI





Company Background

MIL/AERO 65% L3 Communications Boeing General Atomics Raytheon Northrop Grumman (Supplier of the Year) Aethercomm Hughes

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MEDICAL 20% Boston Scientific Sparton Medical Medtronic Illumina

COMMERCIAL/IND 15% Universal Electronics Delta Design Microprobe SRAM PANAVISION These are to name a few of our satisfied customers.

References available upon request



















Industry Accreditations

- ISO 9001:2008, AS9100C Certified
- Mil PRF 31032 & 55110 Certified
- ITAR Registered
- IPC standards 6012B, 6013, 6018, Class 2 and 3(A)
- A member of IPC, SMTA
- Award Winning DLA Certified LAB











Hughes Teams with your Board Layout Designers

A Performance-oriented Resource Partner:

- Gives you one source Layout/build
- Controlled outsourcing
- One point of contact for complete process

Featuring:

- Both original board Layout and repackaging
- Experienced, Senior Layout Engineers
- Hundreds of satisfied clients





Providing a broad range of Layouts including:

- Through-hole conversion
- Ultra high density, BGA-rich boards (25,000+ pins)
- RF and mixed signal boards
- Power supply boards and
- Low-power boards for portable products





Flexible Circuits

- •Greater freedom of design, increased product reliability and reduced space requirement in packaging
- •Designing flexible circuits for new applications can be challenging, we have the expertise.
- •We design and build flex, multilayer flex and rigid flex up to 12 layers.





Talent and Tools

Experience :

- 7 Full-Time Layout Engineers, average over 20 years of PCB layout experience with wide variety of designs
- All are IPC Certified Interconnect Designers (CID)

Tools:

- Allegro XL, PADS/Exp, Altium, Orcad, DxDesigner
- Valor Genesis, Polar and PCB Libraries



Input and Deliverables

Input :

Netlist or Schematic Board Outline Drawing Bill of Materials (Excel preferred) Datasheets for parts Critical Component Locations (if applicable) Critical Routing Constraints (if applicable) Layer Constraints

Deliverables:

Fabrication drawing (PDF and/or DXF) Assembly drawing (PDF and/or DXF) PADS, Allegro, Expedition or Altium database Gerber files, NC-Drill file, and IPC netlist Pick and Place file (component location co-ordinates) Check Plots (PDF) Valor Design for Manufacturing Analysis (additional charge applies)

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Fabrication Materials

- RF Boards
 - Rogers, Taconic, Arlon Nelco
- FR4
 - •Isola, Nelco, Getek
- Polyimide
 - •Isola, Nelco, Arlon
- Flex
 - •Dupont, Panasonic
- Metal Backed Fabrication
 - •Aluminum, Copper, Brass

Fabrication Capabilities

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- 1-50+ layers
- 10 to 1 Mech Drill aspect ratio
- 1 to 1 laser via
- Reverse Pulse Plating
- 100% Netlist testing
- Controlled Impedance TDR
- Controlled dielectrics



Technologies

- Controlled depth drill, laser blind vias
- Burr free plated edges and half-holes
- Multilevel "Cavity" Boards
- Blind and Buried vias
- via-in-pad, conductive filled holes
- Conductors and spaces down to 2 mils
- Multilayer thickness from .015" to .325"
- Buried Resistance and Capacitance
- Metal Backed Boards, Aluminum, Copper etc.



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30 to 1 aspect







Board & Plating Finishes

Board Finishes

• LPI/LDI (liquid photo imageable) solder mask and silk screen

•TAIYO

- Entek / OSP
- Carbon ink

Plating Finishes Available

- HASL (hot air level)
- Lead Free HASL*
- ENIG
- ENIPIG*
- Hard/Soft gold
- Imm. Silver & Tin
- Rhodium/Palladium*
- Solder Fusing

* Outside process





Industry Standards

- ISO 9001:2008, AS9100C Certified
- Mil PRF 31032 & 55110 Certified
- Flight Certified NASA
- ITAR Registered
- IPC standards 6012B, 6013, 6018, Class 2 and 3
- A member of IPC, SMTA





ENGINEERING

Pentalogix CAM Master (Sales) Frontline Valor GenFlex (Production) POLAR SI9000 Stackup Simulation

TESTING

Micro Craft Moving probe Testers Orbotech Discovery 6000 AOI Omega Meter 500 Ionic Contamination Test System Micro-Vu Measuring Center CMI-9000 XRF Zmetrix Impedance Test System





PRODUCTION

Orbotech 9008 LDI Photo Plotter Multiline Tooling **Direct Metallization Line** Plasma Etch **OEM Vacuum lamination Press** Uniline 2000 Drill Concept 1 and 4 Drill Excellon 129 Vision Drill **Excellon 300 Routers** Excellon Co2 & UV laser **Colight Photo Printers** Haas 3 Axis CNC Milling Center





Standard Quality Control Procedures

- 100% Netlist tested with a moving probe tester
- Cross sectioned to ensure acceptable verification and plating
- Coupons and cross sections available upon request
- All Inspectors are IPC 600 certified



In-House Assembly

- 24 hour quick turn PCB assembly, Turnkey or CFM
- Machine placement at up to 15,000 cph
- Through hole, surface mount, ultra fine pitch .3mm, 01005

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- All BGA joints are x-ray inspected
- 100% inspection per IPC 610, J-001
- Conformal Coat
- Flying Probe Test
- Box Build





Printed circuit board quality is directly related to *Manufacturing Expertise* in a *Controlled Environment*

Hughes Circuits has:

- Attracted high technology board designs too complex for the average .
- Leveraged the knowledge gained from building complex board designs for the client's benefit.
- Developed processes and systems which reliably produce great boards whether simple or complex.





All this translates into a Great Partner for You

You Made the Right Choice with Hughes Circuits

- Big enough to do the job perfectly
- Small enough to have a personal touch
- Always keeping clients informed and updated





Hughes Circuits Campus







Hughes Circuits Layout /CAM







Layout Process

10.1 Layout Process Flowchart







IPC CID + Certified Layout







Hughes Circuits PCB Layout









Hughes Circuits CAM Engineering







PCB Fabrication







Fabrication Process

10.2 Fabrication Process Flowchart







Photo Resist







Laser Direct Imaging






Cupric Etcher Inner/Flash Etch







Automated Optical Inspection









Lamination Presses











Drill Machines







129 Intelli Drill with Vision System







High Speed Spindles for Micro-via Drilling

High Density Interconnection (HDI) technology requires change of micro-vias and blind vias. Smaller holes require higher spindle speeds for improved hole wall quality. The full range, high speed spindle also provides increased torque for large hole diameters.

Excellon Z Axis Precision (ZAP) Depth Control Depth control drilling (+/-0.0005") of blind via, counter sink, counter bore, pocket routing and milling rails.





Lasers – Excellon Cobra and ESI CO2/UV



•HIGH POWERED DIODE-PUMPED SOLID-STATE UV LASER

•SEALED SUPER-PULSED CO₂ LASER

•HIGH-SPEED SCANNERS/LINEAR MOTORS

TELECENTRIC LENSES



Specifications

- High power diode-pumped, repetitively q-switched Nd:YAG laser
- Wavelength: 355nm
- Pulse width @ 5kHz: 40 nsec (typical)
- Power: 2W
- Repetition Rate : 5-20 kHz
- Stage Resolution : 1um
- Accuracy : +/- 20um
- Max velocity: 500 mm/sec





Plasma Clean/Etch









Direct Metallization- Hole Plate







Hole Fill & Planarization



Horizontal Via Hole Filling VHF 300 V with Vacuum

Typical Fill Materials: Peters Tatsuta CB-100 San-ei Taiyo



3 -1.25

PERIOD

.....









Pattern Copper Plate







Solder Plate







Ammonia Etcher Outer layers







Strip Solder







Soldermask /Silkscreen











ENIG- Immersion Gold







HASL







Soft / Hard Gold , Imm Tin







Electrical Test







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Haas CNC Machine Center







V-Score







Optical Measuring System







Cross-Section Analysis Lab









Impedance TDR & XRF

The Zmetrix ST600 impedance test system



comes standard with Windows software that automates the data gathering process through an intuitive user interface. Calibration, verification, data logging, and statistical reporting are all fully supported by the software.



Arthuris 2.5



Zmetrix Impedance Test System

CMI900 XRF





Assembly Operation







Assembly Process

10.3 Assembly Process Flowchart







SMT Area







Solder Stencil Printer







SMT Pick and Place







Reflow Ovens







Automated Optical Inspection







Component X-RAY







Selective Solder







Hand Solder







Hot Air Stations









D.I. Water Board Wash








Flying Probe In-Circuit Test







Box-Build and Functional Test Area









Final Inspection







Packaging and Shipment







Thank you for visiting Hughes Circuits